

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type

SSM3J09FU

Management Switch
High Speed Switching Applications

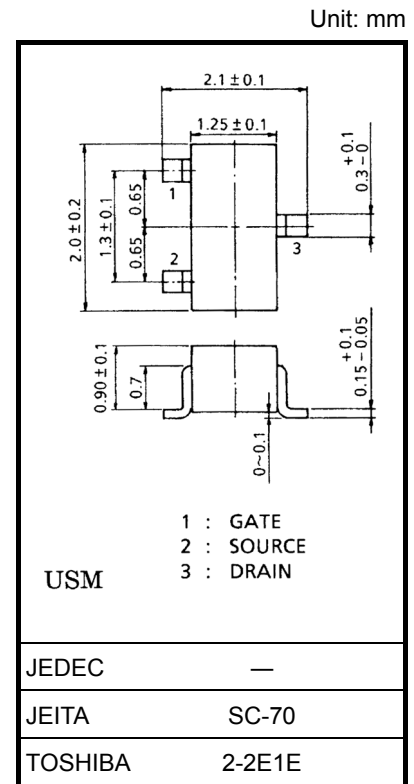
- Small package
- Low on resistance: $R_{on} = 2.7 \Omega$ (max) (@ $V_{GS} = -10$ V)
: $R_{on} = 4.2 \Omega$ (max) (@ $V_{GS} = -4$ V)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Drain-Source voltage	V_{DS}	-30	V
Gate-Source voltage	V_{GSS}	± 20	V
Drain current	DC	I_D	-200
	Pulse	I_{DP}	-400
Drain power dissipation (Ta = 25°C)	P_D (Note 1)	150	mW
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	-55 to 150	°C

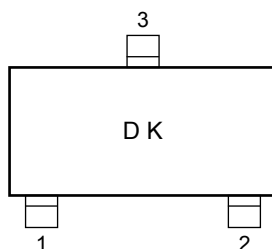
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on FR4 board
(25.4 mm × 25.4 mm × 1.6 t, Cu Pad: 0.6 mm² × 3) Figure 1.



Weight: 0.006 g (typ.)

Marking



Equivalent Circuit (top view)

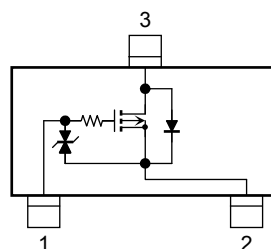
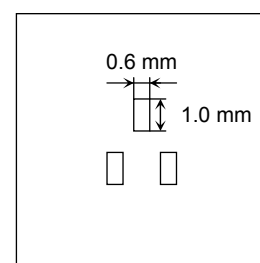


Figure 1: 25.4 mm × 25.4 mm × 1.6 t, Cu Pad: 0.6 mm² × 3



Handling Precaution

When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Start of commercial production
2000-01

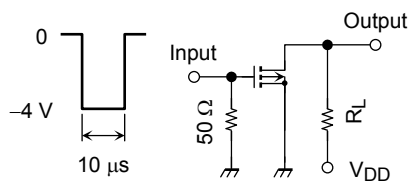
Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit	
Gate leakage current	I_{GSS}	$V_{GS} = \pm 16\text{ V}, V_{DS} = 0$	—	—	± 1	μA	
Drain-Source breakdown voltage	$V_{(BR)DSS}$	$I_D = -1\text{ mA}, V_{GS} = 0$	-30	—	—	V	
Drain cut-off current	I_{DSS}	$V_{DS} = -30\text{ V}, V_{GS} = 0$	—	—	-1	μA	
Gate threshold voltage	V_{th}	$V_{DS} = -5\text{ V}, I_D = -0.1\text{ mA}$	-1.1	—	-1.8	V	
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = -5\text{ V}, I_D = -100\text{ mA}$ (Note2)	115	—	—	mS	
Drain-Source ON resistance	$R_{DS(ON)}$	$I_D = -100\text{ mA}, V_{GS} = -10\text{ V}$ (Note2)	—	2.1	2.7	Ω	
		$I_D = -100\text{ mA}, V_{GS} = -4\text{ V}$ (Note2)	—	3.3	4.2		
		$I_D = -100\text{ mA}, V_{GS} = -3.3\text{ V}$ (Note2)	—	4.0	6.0		
Input capacitance	C_{iss}	$V_{DS} = -5\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$	—	22	—	pF	
Reverse transfer capacitance	C_{rss}	$V_{DS} = -5\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$	—	5	—	pF	
Output capacitance	C_{oss}	$V_{DS} = -5\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$	—	14	—	pF	
Switching time	Turn-on time	t_{on}	$V_{DD} = -5\text{ V}, I_D = -100\text{ mA},$ $V_{GS} = 0\text{ to }-4\text{ V}$	—	85	—	ns
	Turn-off time	t_{off}		—	85	—	ns

Note 2: Pulse test

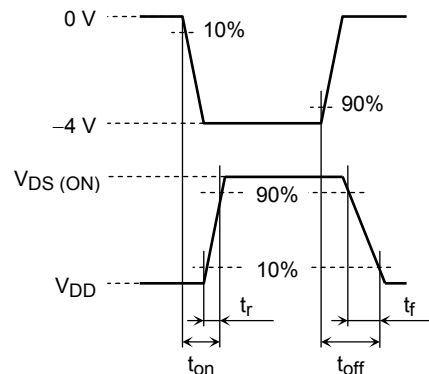
Switching Time Test Circuit

(a) Test circuit



$V_{DD} = -5\text{ V}$
 D.U. $\leq 1\%$
 Input: $t_r, t_f < 5\text{ ns}$
 ($Z_{out} = 50\ \Omega$)
 Common Source
 Ta = 25°C

(b) V_{IN}



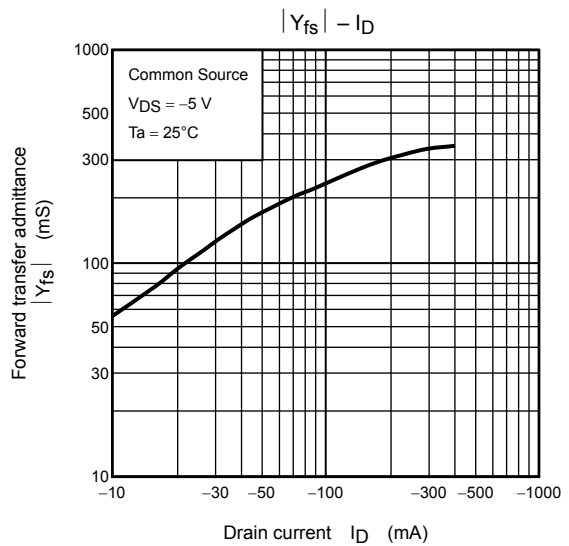
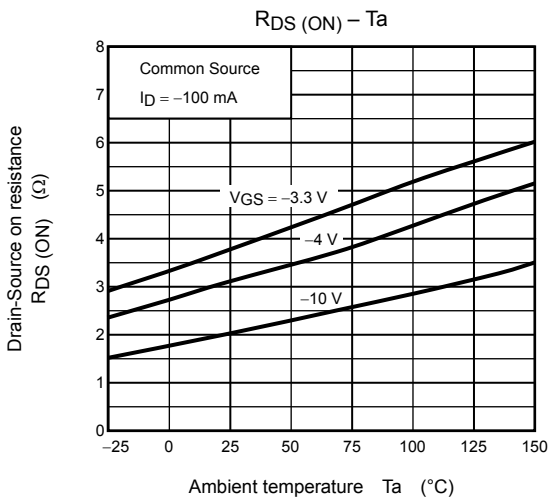
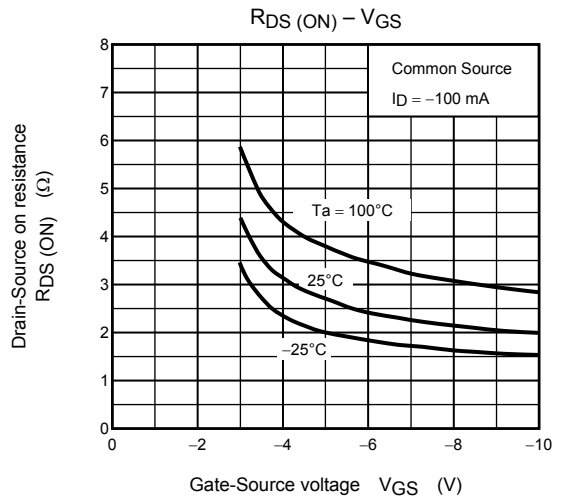
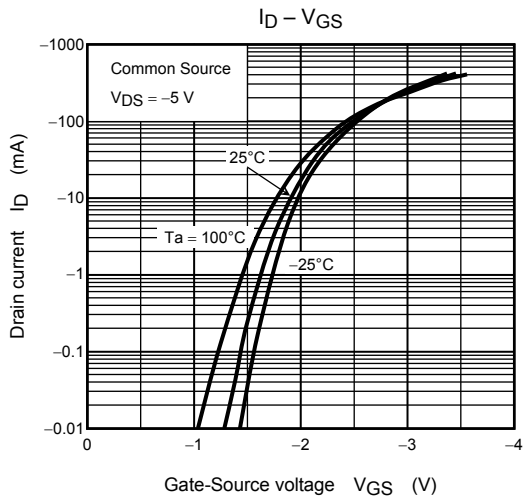
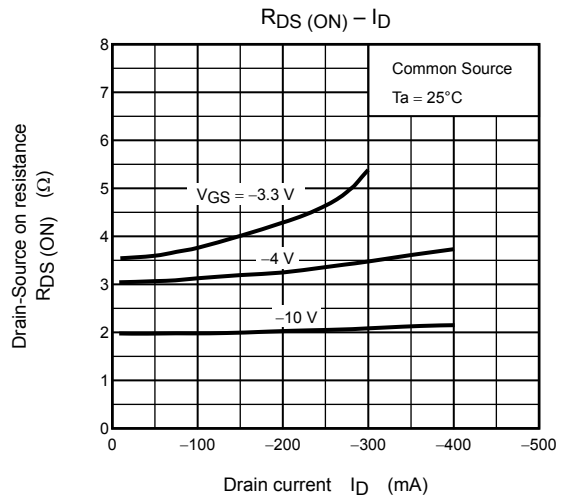
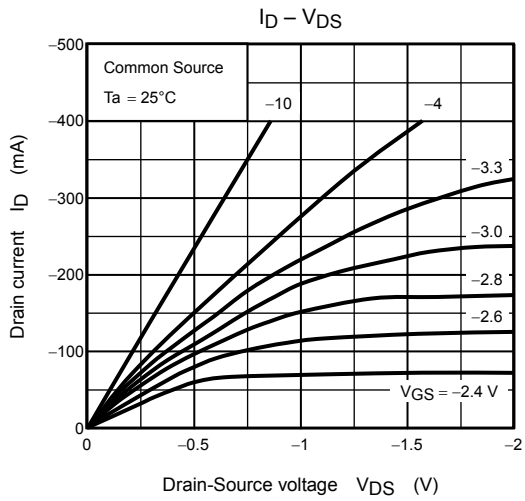
(c) V_{OUT}

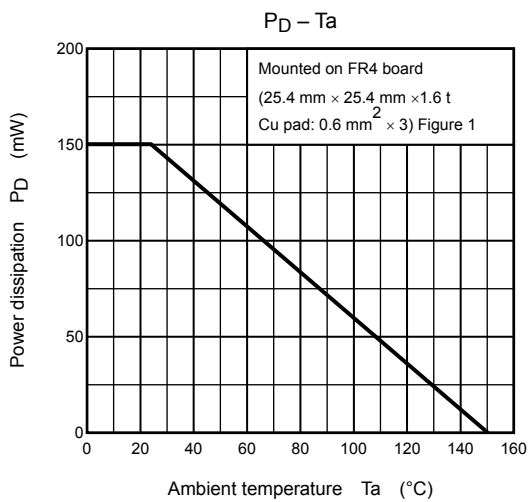
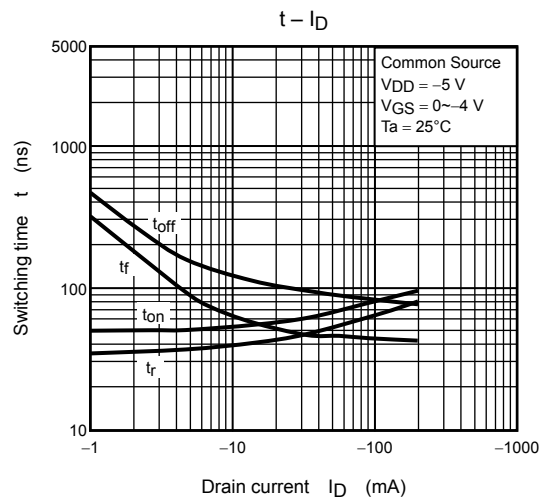
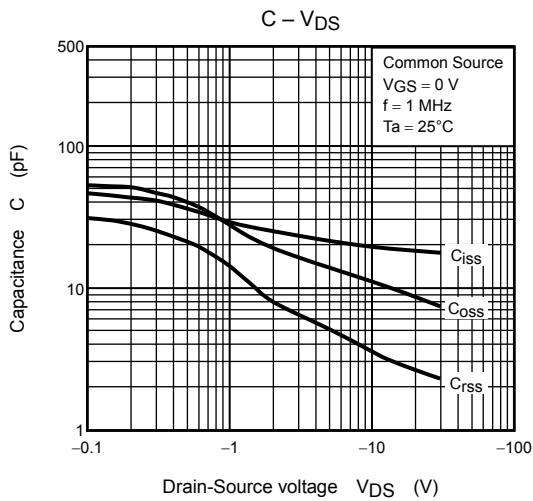
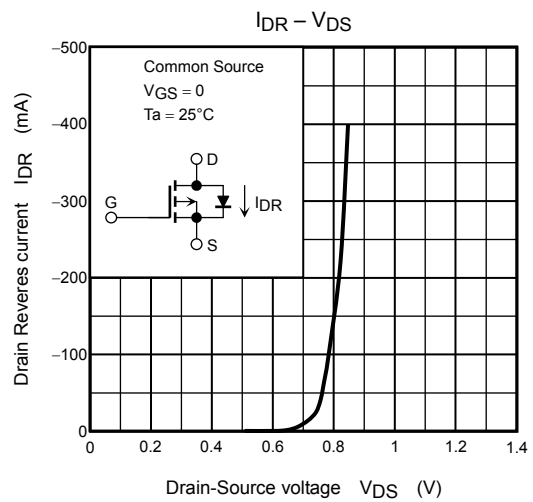
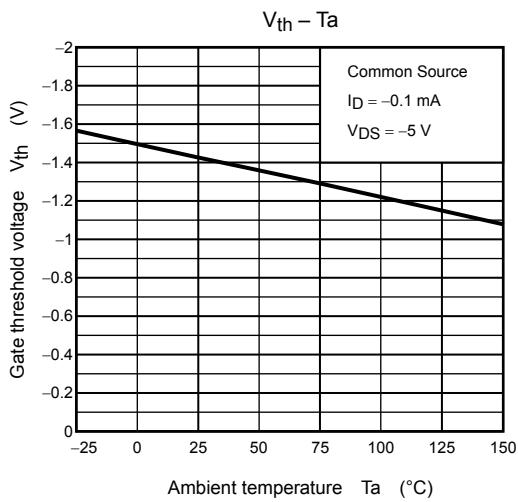
Precaution

V_{th} can be expressed as voltage between gate and source when low operating current value is $I_D = -100\ \mu\text{A}$ for this product. For normal switching operation, $V_{GS(ON)}$ requires higher voltage than V_{th} and $V_{GS(OFF)}$ requires lower voltage than V_{th} .

(relationship can be established as follows: $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$)

Please take this into consideration for using the device.





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